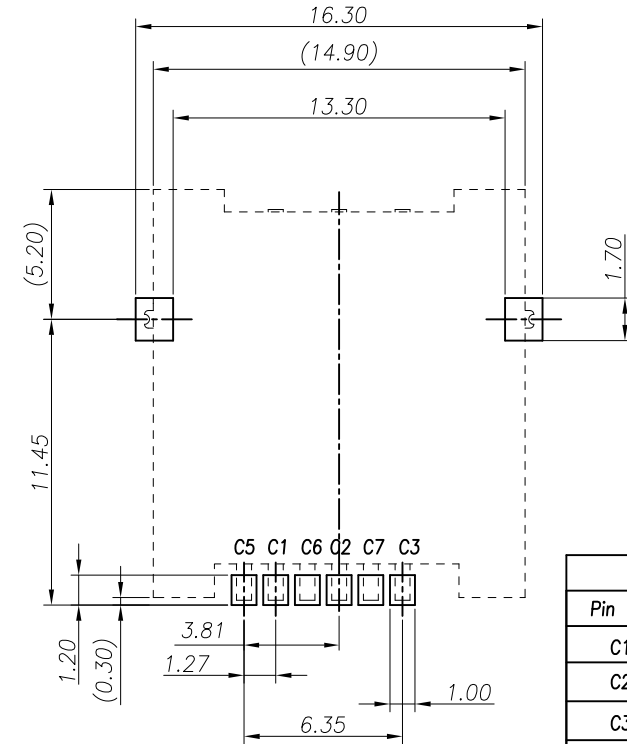
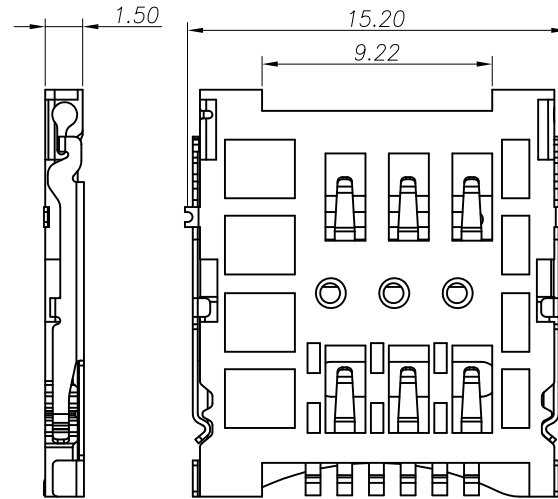
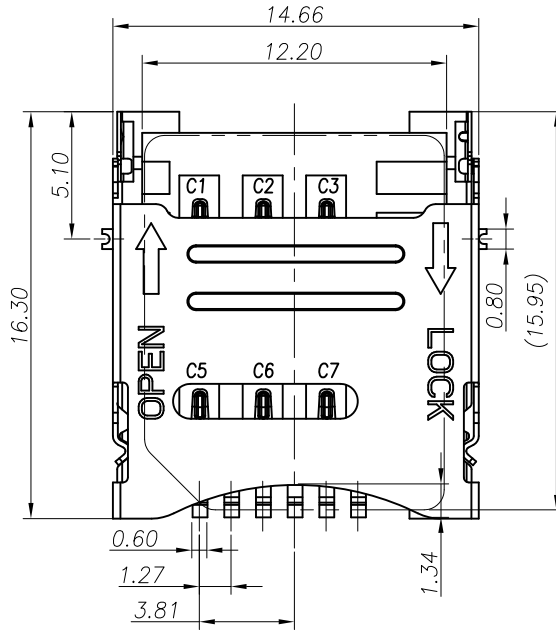


REV.	ECN NO OR DESCRIPTION	REVISED	DATE
▽	PROPOSE ONLY	ALLEN	2015.06.04



Recommended PCB Layout
(General tolerance:±0.05)

SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

NOTES:

1. ELECTRICAL CHARACTERISTICS

- 1-1. CONTACT RESISTANCE: 60 Milliohms Max
- 1-2. INSULATION RESISTANCE: 1,000 Megohms Min.
- 1-3. DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTE.

2. MECHANICAL CHARACTERISTICS

- 2-1. OPERATION TEMPERATURE RANGE: -25°C~+70°C
- 2-2. DURABILITY: 5000 CYCLES

3. MATERIAL:

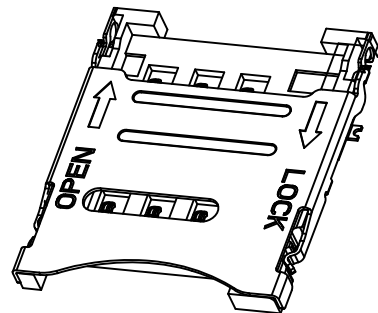
- 3-1. HOUSING: THERMOPLASTIC,UL 94-V0
- 3-2. TERMINAL: PHOSPHOR BRONZE,T=0.15
- 3-3. SHELL: STAINLESS STEEL,T=0.15

4. FINISHED:

- 4-1. TERMINAL: Ni PLATED UNDER,Au PLATED ON CONTACT AREA,G/F PLATED ON SOLDER TAIL
- 4-2. SHELL: Ni PLATED UNDER,G/F PLATED ON SOLDER TAIL

PART No.:

S 0 HG - 15 00 06- 11 G
 SIM CON. 0=WITHOUT POST HG=HINGE TYPE. 15:HEIGHT 1.5mm G=gold flash 11=Product Order Pin NO. 6=6Pin 00=NORMAL TYPE.(ON PCB)



③	TERMINAL	6	C5210-EH,T=0.12	Au 1u" PLATING
②	BASE INSULATOR	1	LCP+GF30%	BLACK
①	SHELL	1	SUS304-H,T=0.12	AU/Ni PLATING
NO.	PART NAME	Q'TY	DESCRIPTION	NOTE
UNLESS OTHERWISE SPECIFIED TOLERANCES				
DECIMALS:		ANGLES:		TITLE
X	:±0.5	X	:±2°	6Pin 1.5H HINGE Micro SIM CARD CONN.
X.X	:±0.20	X.X	:±1°	DWN ALLEN PART NO. SOHG-150006-11G
X.XX	:±0.10			CHKD KEVIN SCALE:1:1 UNIT: mm
				APVD ERIC.W SIZE: A3 SHEET:10F 1 REV: A1
CUSTOMER COPY				

深圳市顺宏康科技有限公司